



### 30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C		
00)/	14.5mΩ @ V <sub>GS</sub> = 10V	9.5A		
30V	15.5mΩ @ V <sub>GS</sub> = 4.5V	9.0A		

## **Features and Benefits**

- DIOFET utilizes a unique patented process to monolithically integrate a MOSFET and a Schottky in a single die to deliver:
  - Low R<sub>DS(ON)</sub> minimize conduction losses
  - Low V<sub>SD</sub> reducing the losses due to body diode conduction
  - Low Q<sub>RR</sub> lower Q<sub>RR</sub> of the integrated Schottky reduces body diode switching losses
  - Low gate capacitance (Q<sub>g</sub>/Q<sub>gs</sub>) ratio reduces risk of shootthrough or cross conduction currents at high frequencies
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- 100% UIS (Avalanche) Rated
- 100% Ra Tested
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

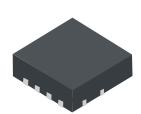
## **Description and Applications**

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

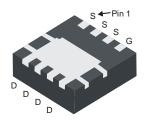
- Backlighting
- Power Management Functions
- DC-DC Converters

### **Mechanical Data**

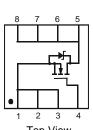
- Case: PowerDI®3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.072 grams (Approximate)



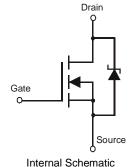
Top View



**Bottom View** 



Top View Pin Configuration



### Ordering Information (Note 5)

Part Number	Case	Packaging		
DMS3014SFGQ-7	PowerDI3333-8	2000/Tape & Reel		
DMS3014SFGQ-13	PowerDI3333-8	3000/Tape & Reel		

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain < 900ppm bromine, < 900ppm chlorine (< 1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product\_compliance\_definitions.html.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

## Marking Information



S29 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)

Document number: DS39684 Rev. 2 - 2



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Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	$V_{DSS}$	30	V		
Gate-Source Voltage	$V_{GSS}$	±12	V		
Continuous Drain Gurrant (Note 7) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	9.5 7.6	А
Continuous Drain Current (Note 7) V <sub>GS</sub> = 10V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	13.0 9.7	А
Continuous Drain Current (Note 7) V <sub>GS</sub> = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	9.0 7.4	А
Continuous Drain Current (Note 7) VGS = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I <sub>D</sub>	12.2 9.3	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	80	Α		
Maximum Continuous Body Diode Forward Current (	I <sub>S</sub>	3.0	А		
Avalanche Current (Note 8) L = 0.1mH	I <sub>AR</sub>	30	Α		
Repetitive Avalanche Energy (Note 8) L = 0.1mH	E <sub>AR</sub>	45	mJ		

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 6)	$P_{D}$	1	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	131	°C/W
Themal Resistance, Junction to Ambient (Note 0)	t<10s	$R_{\theta JA}$	72	°C/W
Total Power Dissipation (Note 7)	$P_{D}$	2.1	W	
Thermal Resistance, Junction to Ambient (Note 7)		Б	63	°C/W
Thermal Resistance, Junction to Ambient (Note 7)	t<10s	$R_{ heta JA}$	35	°C/W
Thermal Resistance, Junction to Case (Note 7)	$R_{ heta JC}$	7.1	°C/W	
Operating and Storage Temperature Range	$T_{J_1}T_{STG}$	-55 to +150	°C	

Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 8.  $I_{AR}$  and  $E_{AR}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.



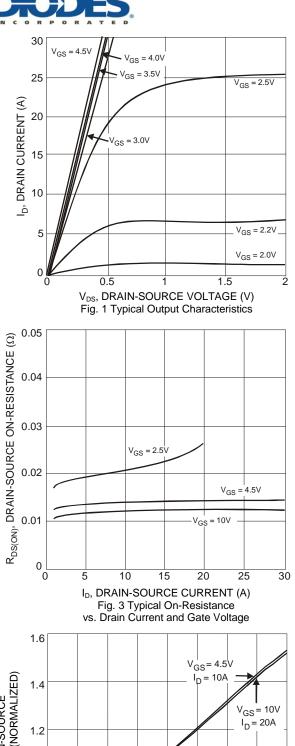
# Electrical Characteristics (T<sub>A</sub> = +25°C, unless otherwise specified.)

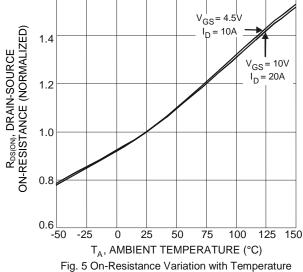
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	100	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	1.0	_	2.2	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance		_	9	14.5	mΩ	$V_{GS} = 10V, I_D = 10.4A$	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	10	15.5	11122	$V_{GS} = 4.5V, I_D = 10.4A$	
Forward Transfer Admittance	Y <sub>fs</sub>	_	23	_	S	$V_{DS} = 5V, I_{D} = 10.4A$	
Diode Forward Voltage	V <sub>SD</sub>	_	0.4	0.55	V	$V_{GS} = 0V$ , $I_S = 1A$	
DYNAMIC CHARACTERISTICS (Note 10)	*	•	•		•		
Input Capacitance	C <sub>iss</sub>	_	2296	4310	pF	.,, .,	
Output Capacitance	Coss	_	164	_	pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0V, -f = 1.0MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	120	_	pF	-1 = 1.0WH2	
Gate Resistance	$R_g$	0.26	1.3	2.34	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge V <sub>GS</sub> = 4.5V	Qg	_	19.3	_	nC		
Total Gate Charge V <sub>GS</sub> = 10V	Qg	_	45.7	_	nC	\	
Gate-Source Charge	Qgs	_	5.0	_	nC	$V_{DS} = 15V, V_{GS} = 10V, I_D = 10.4A$	
Gate-Drain Charge	$Q_{gd}$	_	2.9	_	nC	1	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	5.5	_	ns		
Turn-On Rise Time	t <sub>R</sub>	_	24.4	_	ns	$V_{GS} = 10V, V_{DS} = 15V,$	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	33.1	_	ns	$R_G = 3\Omega$ , $R_L = 1.2\Omega$	
Turn-Off Fall Time	t <sub>F</sub>	_	6.6	_	ns	1	
Reverse Recovery Time	t <sub>RR</sub>	_	12.9	_	ns	$I_F = 13A$ , $di/dt = 500A/\mu s$	
Reverse Recovery Charge		_	8.0	_	nC	$I_F = 13A$ , di/dt = 500A/ $\mu$ s	

 Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to product testing. Notes:

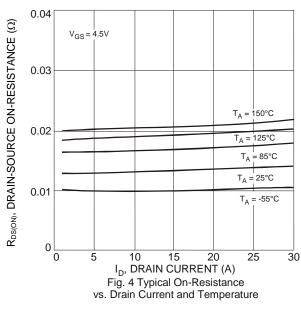








30  $V_{DS} = 5V$ 25 ID, DRAIN CURRENT (A) 20 15 10 5 = -55°C 0 0 1.5 3  $V_{GS}$ , GATE-SOURCE VOLTAGE (V) Fig. 2 Typical Transfer Characteristic



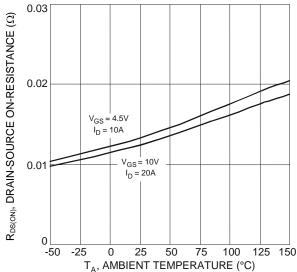
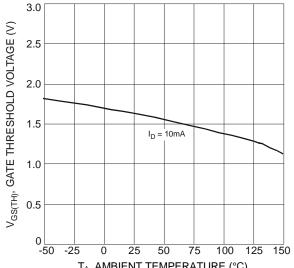


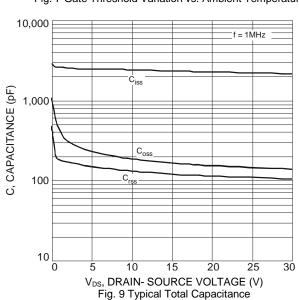
Fig. 6 On-Resistance Variation with Temperature







 $T_{A},\,AMBIENT\,TEMPERATURE$  (°C) Fig. 7 Gate Threshold Variation vs. Ambient Temperature



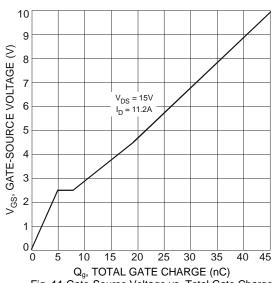
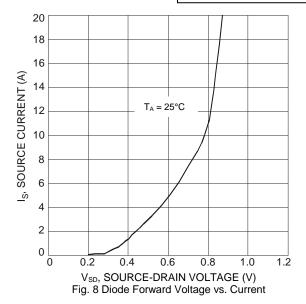
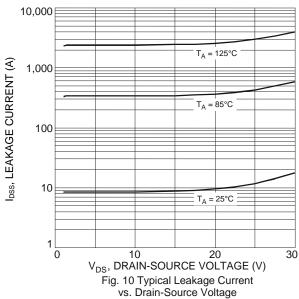
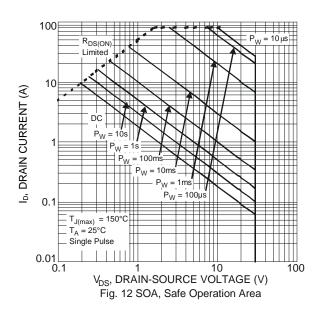


Fig. 11 Gate-Source Voltage vs. Total Gate Charge









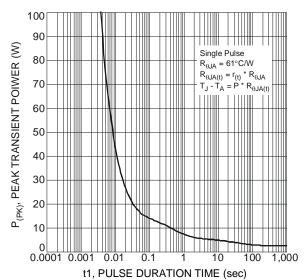
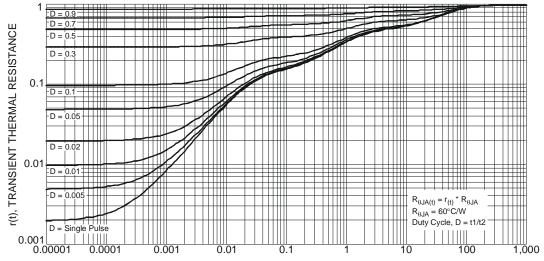


Fig. 13 Single Pulse Maximum Power Dissipation



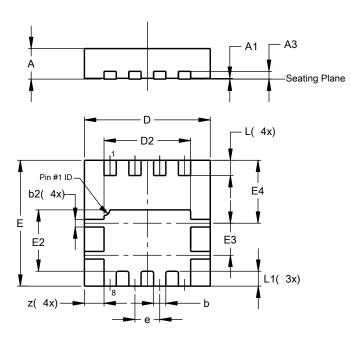
t1, PULSE DURATION TIME (sec) Fig. 14 Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8

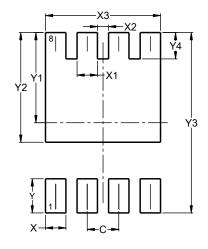


PowerDI3333-8					
Dim	Min	Max	Тур		
Α	0.75	0.85	0.80		
A1	0.00	0.05	0.02		
A3	_	_	0.203		
b	0.27	0.37	0.32		
b2	0.15	0.25	0.20		
D	3.25	3.35	3.30		
D2	2.22	2.32	2.27		
Е	3.25	3.35	3.30		
E2	1.56	1.66	1.61		
E3	0.79	0.89	0.84		
E4	1.60	1.70	1.65		
е	1	-	0.65		
L	0.35	0.45	0.40		
L1	_	_	0.39		
Z	_	_	0.515		
All Dimensions in mm					

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI3333-8



Dimensions	Value (in mm)
С	0.650
X	0.420
X1	0.420
X2	0.230
Х3	2.370
Y	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540



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